	Application No.	Applicant(s)
Notice of Allowability	40/000 000	NAUTZIONAANINI ET AL
	10/602,298 <b>Examiner</b>	WITZIGMANN ET AL.
·		
	Phillip Nguyen	2828
The MAILING DATE of this communication appears on the cover sheet with the correspondence address All claims being allowable, PROSECUTION ON THE MERITS IS (OR REMAINS) CLOSED in this application. If not included herewith (or previously mailed), a Notice of Allowance (PTOL-85) or other appropriate communication will be mailed in due course. THIS NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIGHTS. This application is subject to withdrawal from issue at the initiative of the Office or upon petition by the applicant. See 37 CFR 1.313 and MPEP 1308.		
1. This communication is responsive to 10/7/05.		
2. The allowed claim(s) is/are 24-42.		
3. ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) ☐ All b) ☐ Some* c) ☐ None of the:		
Certified copies of the priority documents have been received.		
Certified copies of the priority documents have been received in Application No		
3. Copies of the certified copies of the priority documents have been received in this national stage application from the		
International Bureau (PCT Rule 17.2(a)).		
* Certified copies not received:		
Applicant has THREE MONTHS FROM THE "MAILING DATE" of this communication to file a reply complying with the requirements noted below. Failure to timely comply will result in ABANDONMENT of this application.  THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		
4. A SUBSTITUTE OATH OR DECLARATION must be submitted. Note the attached EXAMINER'S AMENDMENT or NOTICE OF INFORMAL PATENT APPLICATION (PTO-152) which gives reason(s) why the oath or declaration is deficient.		
5. CORRECTED DRAWINGS ( as "replacement sheets") must be submitted.		
(a) ☐ including changes required by the Notice of Draftsperson's Patent Drawing Review ( PTO-948) attached		
1) hereto or 2) to Paper No./Mail Date		
(b) ☐ including changes required by the attached Examiner's Amendment / Comment or in the Office action of Paper No./Mail Date		
Identifying indicia such as the application number (see 37 CFR 1.84(c)) should be written on the drawings in the front (not the back) of each sheet. Replacement sheet(s) should be labeled as such in the header according to 37 CFR 1.121(d).		
6. DEPOSIT OF and/or INFORMATION about the deposit of BIOLOGICAL MATERIAL must be submitted. Note the attached Examiner's comment regarding REQUIREMENT FOR THE DEPOSIT OF BIOLOGICAL MATERIAL.		
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Attachment(s) 1. ☑ Notice of References Cited (PTO-892)	5 ☐ Notice of Informal P	atent Application (PTO-152)
Notice of Draftperson's Patent Drawing Review (PTO-948)	6.  Interview Summary	(PTO-413),
3. Information Disclosure Statements (PTO-1449 or PTO/SB/0	Paper No./Mail Dat 98), 7. ⊠ Examiner's Amendr	re nent/Comment
Paper No./Mail Date	8. 🛛 Examiner's Stateme	ent of Reasons for Allowance
of Biological Material	9.	

Application/Control Number: 10/602,298

Art Unit: 2828

## **EXAMINER'S AMENDMENT**

Page 2

1. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

2. Authorization for this examiner's amendment was given in a telephone interview with Jon Christensen on 10/31/2005.

3. The application has been amended as follows:

In the claims:

Claim 24: in lines 18-19, delete "thereby reducing the likelihood of contact with the active device"

Claim 28: in lines 19-20, delete "thereby reducing the likelihood of contact with the active area"

Claim 35: in lines 18-19, delete "thereby reducing the likelihood of contact with the active area"

Claim 42: in lines 17-18, delete "thereby reducing the likelihood of contact with the active device"

## Allowable Subject Matter

4. The following is an examiner's statement of reasons for allowance: Claims 24-42 are allowed because the prior art fail to teach or fairly suggest an apparatus and method for protecting a semiconductor device including a plurality of metallic pads around the periphery of an active device only in said inactive areas on the surface of the wafer, each pad having a greater relative height measured from the surface from the wafer than the height of any portion of a respective active device such that the pick and place tool only make contact with the pads surrounding the active devices of the wafer.

Wu ('888) discloses a semiconductor device in Fig. 2 with a pad that has a plurality of metallic pads 226 having greater relative height measured from the wafer compared to the active region; however, the pads are also disposed on the active area (210) and attached with the wire 224 which is not for the pick and place to contact with.

Cai ('779) discloses in Fig. 3 a plurality of bonding pads 302 which also have greater relative height compared to the active area. However, Cai is silent about using the specific pads for preventing pick and place tool to make contact with the active area /device by contacting with the pads.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue

Art Unit: 2828

fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

## Communication Information

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Phillip Nguyen whose telephone number is 571-272-1947. The examiner can normally be reached on 9:00 AM - 6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, MINSUN HARVEY, can be reached on 571-272-1835. The fax phone number for the organization where this application or proceeding is assigned is **571-273-8300**.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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